

SAMXON ELECTRONICS COMPONENTS CO, LTD PRODUCT SPECIFICATION 規格書

CUSTOMER: (客戶): DATE: (日期):2017-11-02

CATEGORY (品名)	: ALUMINUM ELECTROLYTIC CAPACITORS
DESCRIPTION (型号)	: KM 400V56μF(φ12.5x30)
VERSION (版本)	: 01
Customer P/N	:
SUPPLIER	:

SUPPL	SUPPLIER		CUS	ГOMER
PREPARED (拟定)	CHECKED (审核)	A	APPROVAL (批准)	SIGNATURE (签名)
李婷	刘渭清			

		SPECIFICATIONALTERNATION HISTORY RECORDSKM SERIESRECORDS						STORY
Rev.	Date	<u> </u>		<u>ao</u>	Contents	Purpose	Drafter	Annrovor
Kev.	Date	IVIAIK	Pa	ge	Contents	Puipose	Dianei	Approver
		1		I		1	· ·	I
	Version		01				Page 1	

	SAMXON ELECTR COMPANY LIMI			C2 SPE	CTROLY APACITC CIFICAT M SERIE	OR TION							
	e 1 Product Dimen	sions and	Characteristi	ics							Unit:	mm	
	Safety vent for $\geq \Phi$ 6.3]	$\oint \phi d \pm 0.05$	-(1		- 1 F±0.5		α I β	$-<20: \alpha=1.5;$ ΦD<20: β=			β=1.0	
	$ \xrightarrow{L^+ \alpha}_{-1.0} $	<mark>↓ 15 min</mark>	→ 4 min	, ,	ΦD ⁺ _{-0.5}	<u> </u>		* lf it is : surfa		there is	s no bu	ilge from	the flat rubb
		WV Ca	· fr - f		τ an δ	Leakage	Max Ripple Current at	surfa Load	ce. Dime	there is ension mm)	s no bu		the flat rubb
No.	SAMXON Part No.	•	· fr - f	Temp. range(°℃)	1	Leakage Current (µA,2min)	Max Ripple	surfa	ce. Dime	ension	s no bu	lge from	the flat rubt

2. Part N 3. Const 4. Chara 4.1 Rated vo 4.2 Capacit 4.3 Leakage 4.4 $\tan \delta$ 4.5 Termina 4.6 Temper 4.7 Load life 4.8 Shelf 1 4.9 Surge t 4.10 Vibra 4.11 Solde 4.12 Resist 4.13 Chang	ife test est
6. Const 4. Chara 4.1 Rated vo 4.2 Capacit 4.3 Leakage 4.4 $\tan \delta$ 4.5 Termina 4.6 Temper 4.7 Load life 4.8 Shelf 1: 4.9 Surge t 4.10 Vibra 4.11 Solde 4.12 Resist 4.13 Chang	ruction cteristics 5. bltage & Surge voltage ance (Tolerance) e current al strength ature characteristic e test ife test est
4. Chara 4.1 Rated vo 4.2 Capacit 4.3 Leakage 4.4 $\tan \delta$ 4.5 Termina 4.6 Temper 4.7 Load life 4.8 Shelf I 4.9 Surge t 4.10 Vibra 4.11 Solde 4.12 Resist 4.13 Chang	cteristics 5. bltage & Surge voltage ance (Tolerance) e current al strength ature characteristic e test ife test est
4.1 Rated vo 4.2 Capacit 4.3 Leakage 4.4 $\tan \delta$ 4.5 Termina 4.6 Temper 4.7 Load life 4.8 Shelf 1 4.9 Surge t 4.10 Vibra 4.11 Solde 4.12 Resist 4.13 Chang	5- oltage & Surge voltage ance (Tolerance) e current al strength ature characteristic e test ife test est
4.2 Capacit 4.3 Leakage 4.4 $\tan \delta$ 4.5 Termina 4.6 Temper 4.7 Load life 4.8 Shelf 1 4.9 Surge t 4.10 Vibra 4.11 Solde 4.12 Resist 4.13 Chang	oltage & Surge voltage ance (Tolerance) e current al strength ature characteristic e test ife test est
4.3 Leakage 4.4 $\tan \delta$ 4.5 Termina 4.6 Temper 4.7 Load life 4.8 Shelf 1 4.9 Surge t 4.10 Vibra 4.11 Solde 4.12 Resist 4.13 Chang	e current al strength ature characteristic e test if e test e st
4.4 $\tan \delta$ 4.5 Termina 4.6 Temper 4.7 Load life 4.8 Shelf 1 4.9 Surge t 4.10 Vibra 4.11 Solde 4.12 Resist 4.13 Chang	al strength ature characteristic e test ife test est
 4.5 Termina 4.6 Temper 4.7 Load life 4.8 Shelf 1 4.9 Surge t 4.10 Vibra 4.11 Solde 4.12 Resist 4.13 Chang 	ature characteristic e test ife test est
 4.6 Temper 4.7 Load life 4.8 Shelf 1 4.9 Surge t 4.10 Vibra 4.11 Solde 4.12 Resist 4.13 Chang 	ature characteristic e test ife test est
 4.7 Load life 4.8 Shelf 1 4.9 Surge t 4.10 Vibra 4.11 Solde 4.12 Resist 4.13 Chang 	e test ife test est
4.8 Shelf 1 4.9 Surge t 4.10 Vibra 4.11 Solde 4.12 Resist 4.13 Chang	ife test est
4.9 Surge t 4.10 Vibra 4.11 Solde 4.12 Resist 4.13 Chang	est
4.10 Vibra 4.11 Solde 4.12 Resist 4.13 Chang	
4.11 Solde 4.12 Resist 4.13 Chang	
4.12 Resist 4.13 Chang	11011
4.13 Chang	rability test
	ance to solder heat
1 11 Dama	ge of temperature
-	heat test
4.15 Vent tes	
4.16 Maximu	m permissible (ripple current)
5. List of Substance	"Environment-related Substances to be Controlled ('Controlled es')"
	ent: Application Guidelines 12

Version	01	Page	3

ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

1. Application

This specification applies to polar Aluminum electrolytic capacitor (foil type) used in electronic equipment. Designed capacitor's quality meets IEC60384.

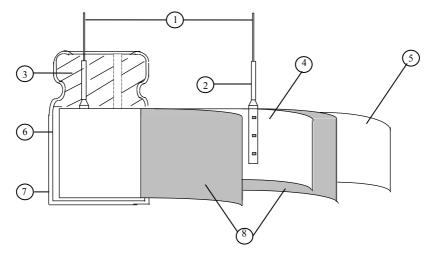
2. Part Number System 89 101112 1314 123 4 5 6 7 1516 17 тс Ρ EGS 1 D11 S 0 5 м 1 н SAMXON SLEEVE PRODUCT LINE MATERIAL SERIES CAPACITANCE TOI VOLTAGE CASE SIZE TYPE Cap(MFD) Tolerance (%) Code Code Voltage (W.V.) Code Case Size Feature Code SAMXON Product Li ries ESM EKF ESS EKS EGS EKM EKG EOM EZM 0D (4) Co RR For internal use only 3 B .5 1 4 C Radial bulk 0.1 104 ± 5 J 2.5 0E 5 D 6.3 E 10 G 12.5 1 13 5.5 7 (The product lines 4 0G we have H.A.B.C.D. Ammo Taping 0.22 224 6.3 OJ к E,M or 0,1,2,3,4,5,9) ±10 0K 8 0.33 334 2.0mm Pitch тт 10 1A 553544AK7L8MNC ±15 L 12.5 1B 2.5mm Pitch τu EZS 0.47 474 1C 16 EGI м 20 1D ±20 105 3.5mm Pitch тν Sleeve Material 1 14 Cod 듣증 25 EGK EGE EGD EGC 1E 16 тс PET P 30 11 5.0mm Pitch 2.2 225 Ν ±30 32 13 18 Lead Cut & Form 35 ERS 3.3 335 1V -40 w ERF 225 N 255 O 30 P 34 W 355 Q 40 R 42 4 45 6 51 S 3.5 T 76 U 80 8 90 X 0, (mr) costs 40 1G СВ-Туре СВ 42 4.7 475 1**M** -20 0 А ER 50 1H ERI СЕ-Туре CE 10 106 57 1L ERD -20 +10 С 63 1J HE HE-Type 22 226 71 **1**S 45 51 53.5 76 80 90 100 ER. 75 1**T** 6 -20 +40 ERE × KD-Type ĸD 336 ERC EFA ENP 33 80 1K 85 1R -20 +50 FD-Type FD s 47 476 90 19 ENH ERV ERY 100 2A 5 455 5 065 5 06 4 54 7 07 7 77 7 77 2 T2 1 11 5 1A 2 12 5 1B 3 13 3 13 5 1C 0 200 5 25 5 25 5 25 5 23 0 30 5 3A 5 35 5 5 35 -10 0 4.5 ЕН-Туре EΗ в 107 100 120 20 5.4 EAP EQP EDP 125 2B PCB Termial 227 -10 +20 220 v 150 2Z 160 2C 10 sw -10 +30 330 337 Q 180 2P 11.5 200 2D Snap-in sx 12 2.5 13 3.5 EKF EEF 477 470 12 -10 +50 215 22 т 13.L 20 2; EFF 220 2N sz 2200 228 23 -5 +10 230 EVP EGP EWR EWU EWT EWX EWF EWS EWH EWL EWB VSS Е 250 2E Lug SG 29.5 22000 229 -5 +15 275 2Т F 3 300 21 05 33000 339 -5 +20 310 2R 35 G 06 315 2F 50 80 1L 1K 1M 1P 47000 479 330 2U 0 +20 R Т5 350 2V 100000 10T Screw 360 2X 0 +30 0 т6 375 2Q VNS 150000 15T 40 50 10 1R 1E 1S 1F 1T 1U 1V 0 +50 385 2Y I. D5 2G 400 220000 22T +5 +15 420 2M z D6 VZS 450 2W 330000 ззт +5 +20 D 500 2H 550 25 1000000 10M +10+50 Y 600 26 2J 1500000 15M 630 +10 +30 н 2200000 22M 3300000 33M 5

Version

01

3. Construction

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be impregnated with electrolyte will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber, then finished by putting on the vinyl sleeve.



	Component	Material
1	Lead line	Tinned CP wire (Pb Free)
2	Terminal	Aluminum wire
3	Sealing Material	Rubber
4	Al-Foil (+)	Formed aluminum foil
5	Al-Foil (-)	Etched aluminum foil or formed aluminum foil
6	Case	Aluminum case
7	Sleeve	РЕТ
8	Separator	Electrolyte paper

4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests are as follows:

Ambient temperature	:15°C to 35°C
Relative humidity	: 45% to 85%
Air Pressure	: 86kPa to 106kPa

If there is any doubt about the results, measurement shall be made within the following conditions:

Ambient temperature	$: 20^{\circ}C \pm 2^{\circ}C$
Relative humidity	: 60% to 70%
Air Pressure	: 86kPa to 106kPa

Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage See table 1 temperature range.

As to the detailed information, please refer to table 2.

Version	01		Page	5
---------	----	--	------	---

ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

Tabl					пг						
ITEM PERFORMANCE											
	Rated voltage	WV (V.DC)	6.3	10	1	6	25	35	50	63	100
	(WV)	SV (V.DC)	8	13	2	0	32	44	63	79	125
4.1											
	Surge	WV (V.DC)	160	200	220	250	350	400	420	450	
	voltage (SV)	SV (V.DC)	200	250	270	300	400	450	470	500	
4.2	Nominal capacitance (Tolerance)	<condition>Measuring Frequency: $120Hz \pm 12Hz$Measuring Voltage: Not more than $0.5Vrms$Measuring Temperature: $20 \pm 2^{\circ}C$<criteria>Shall be within the specified capacitance tolerance.</criteria></condition>									
4.3	Leakage current	<condition></condition> Connecting the capacitor with a protective resistor $(1k \Omega \pm 10 \Omega)$ in series for 2 minutes, and then, measure Leakage Current. <criteria></criteria> Refer to Table 1									
4.4	tan δ	Condition> See 4.2, Norm Capacitance, for measuring frequency, voltage and temperature. <criteria> Refer to Table 1</criteria>									
4.5	Terminal strength	<condition></condition> Tensile Strength of Terminals Fixed the capacitor, applied force to the terminal in lead out direction for 10 ± 1 seconds. Bending Strength of Terminals. Fixed the capacitor, applied force to bent the terminal (1~4 mm from the rubber) for 90° within 2~3 seconds, and then bent it for 90° to its original position within 2~3 seconds. Diameter of lead wire Tensile force N Bending force N 0.5mm and less 5 (0.51) 2.5 (0.25) Over 0.5mm to 0.8mm 10 (1.0) 5 (0.51) <criteria></criteria> No noticeable changes shall be found, no breakage or looseness at the terminal.									

01

		<condi< th=""><th>tion></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th><th></th></condi<>	tion>								
				ting Tempe	rature(°C`			Time			
			1	$\frac{1000}{20\pm 2}$			to read	ch thermal	equilib	rium	
			2	-40(-25)				ch thermal	-		
			3					ch thermal			
			4	$\frac{20\pm2}{105\pm2}$							
								ch thermal			
		<criter< td=""><td>5</td><td>20±2</td><td>2</td><td>Time</td><td>to read</td><td>ch thermal</td><td>equilit</td><td>rium</td><td></td></criter<>	5	20±2	2	Time	to read	ch thermal	equilit	rium	
4.6	Temperature characteristi cs	a. tan more th b. In st more th	δ shall be with an 8 times of the times of the times of the formula to be an the specification of the specific	f its specific hall be with ied value.	ed value. nin the lin	nit of Iter	n 4.4T	he leakag	e currei	nt shall r	not
		c. At-4 table.	0℃ (-25℃),	Impedance	(z) ratio	shall not o	exceed	the value	of the	following	g
			Voltage (V)	6.3	10	16	25	35	50	63	
		-	C/Z+20°C	5	4	3	2	2	2	2	_
			C/Z+20°C	10	8	6	4	3	3	3	_
		2.10	0,2,200	10		T	•	5	5		
		-	Voltage (V)	100	160~22	0 250~	-350	400~42		50	
		_	C/Z+20℃	2	3	4	ŀ	6	1	5	
			C/Z+20℃	3			-				
		For capa	acitance valu	e > 1000 μ							
	Add 1.0 per another 1000 µ F for Z-40 °C/Z							C/Z+20℃	2.		
		Capacitance, tan δ , and impedance shall be measured at 120Hz.									
4.7LoadCondition> According to IEC60384-4No.4.13 methods, The capacitor is stored 105°C ± 2 with DC bias voltage plus the rated ripple current for Ta DC and ripple peak voltage shall not exceed the rated working product should be tested after 16 hours recovering time at atmosphe result should meet the following table: Criteria> The characteristic shall meet the following requirements.							ble 1. (voltage	(The sun e) Then	n of the		
	test		eakage curre		Value in						
			Capacitance (
			an δ	-ininge	Within $\pm 20\%$ of initial value.Not more than 200% of the specified value.						
			Appearance					e of electr			
		1	ippeurunee		There sh		Iounue		oryte.		
4.8	Shelf life test	<condition>The capacitors are then stored with no voltage applied at a temperature of $105 \pm 2^{\circ}$C for$1000+48/0$ hours. Following this period the capacitors shall be removed from the testchamber and be allowed to stabilized at room temperature for 4~8 hours. Next theyshall be connected to a series limiting resistor($1k \pm 100 \Omega$) with D.C. rated voltageapplied for 30min. After which the capacitors shall be discharged, and then, tested thecharacteristics.</condition>									
	Version		01						Page	7	

		<criteria></criteria>					
		The characteristic shall meet the following requirements.					
	Shelf	Leakage current Value in 4.3 shall be satisfied					
4.8	life	Capacitance ChangeWithin $\pm 20\%$ of initial value.					
4.0	test	tan δ Not more than 200% of the specified value.					
	test	AppearanceThere shall be no leakage of electrolyte.					
		Remark: If the capacitors are stored more than 1 year, the leakage current may					
		increase. Please apply voltage through about 1 k Ω resistor, if necessary.					
4.9	Surge test						
	Vibration test	Condition> The following conditions shall be applied for 2 hours in each 3 mutually perpendicular directions.					
		Vibration frequency range : 10Hz ~ 55Hz Peak to peak amplitude : 1.5mm Sweep rate : 10Hz ~ 55Hz ~ 10Hz in about 1 minute Mounting method: The capacitor with diameter greater than 12.5mm or longer than 25mm must be fixed in place with a bracket.					
		4mm or less Within 30°					
4.10							
		\ / To be soldered					
		<criteria></criteria>					
		After the test, the following items shall be tested: No intermittent contacts, open or short circuiting.					
		No damage of tab terminals or electrodes.					
		AppearanceNo mechanical damage in terminal. No leakage of electrolyte or swelling of the case. The markings shall be legible.					

Version	01			8	
---------	----	--	--	---	--

ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

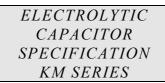
4.11Solderability $< Condition>$ The capacitor shall be tested under the following conditions: Soldering temperature $: 245\pm3^{\circ}C$ Dipping depth $: 2mm$ Dipping speed $: 25\pm2.5mm/s$ $= 2$										
4.11Solderability testSoldering temperature Dipping speed $: 245\pm 3^{\circ}C$ Dipping speed $: 25\pm 2.5 mm/s$ Dipping time $: 3\pm 0.5s$ 4.11Solderability testCoating qualityA minimum of 95% of the surface being immersed I_{12} Resistance to solder heatA minimum of 95% of the surface being immersed4.12Resistance to solder heat4.13Change of temperature testNot more than the specified value. Temperature (40°C) (-25°C) 30±2 Minutes (2)Rated high temperature (+105°C) 30±2 Minutes (1)±0(3)=1 cycle, total 5 cycle4.13Change of test4.13Change of test4.14Change of test4.15Change of test4.16Change of test4.17Change of test4.18Change of test4.19Change of test4.113Change of test <th< td=""><td></td><td></td><td></td><td></td><td></td><td></td><td></td></th<>										
4.11Solderability testDipping depth impring speed $25\pm2.5 \text{ mm/s}$ $25\pm2.5 \text{ mm/s}$ $25\pm2.5 \text{ mm/s}$ $3\pm0.5 \text{ s}$ $<\mathbf{Criteria>}$ 4.11Resistance to solder heat test $\mathbf{Condition>}$ Terminals of the capacitor shall be immersed into solder bath at $260\pm5^\circ\text{Cfor10}\pm$ Isconds to $1.5-2.0 \text{ mm}$ from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for 1-2 hours before measurement. $\mathbf{Criteria>}$ 4.12Resistance to solder heat test $\mathbf{Capacitance Change}$ Within $\pm 10\%$ of initial value. tan δ Not more than the specified value. Appearance There shall be no leakage of electrolyte.4.13Change of test $\mathbf{Ccondition>}$ Temperature test4.13Change of temperature test $\mathbf{Cirteria>$ Temperature (40°C) (25°C) 30 ± 2 Minutes ($1)\pm0(3)=1$ cycle, total 5 cycle $\mathbf{Cirteria>}$ 4.13Change of temperature test $\mathbf{Condition}$ Temperature (40°C) (25°C) 30 ± 2 Minutes ($1)\pm0(3)=1$ cycle, total 5 cycle $\mathbf{Cirteria>}$ 4.13Change of temperature test $\mathbf{Condition}$ The characteristic shall meet the following requirement $\mathbf{Leakage current}$ Not more than the specified value. $\mathbf{Cirteria>}$ The characteristic shall meet the following requirement $\mathbf{Leakage current}$ $\mathbf{Not more than the specified value.\mathbf{A}\mathbf{Not more than the specified value.\mathbf{A}\mathbf{D}\mathbf{Condition>}The characteristic shall meet the following requirement\mathbf{Leakage current}\mathbf{Not more than the specified value.\mathbf{A}\mathbf{P}\mathbf{P}\mathbf{Not more than the specified value.\mathbf{A}\mathbf{P}\mathbf{P}Not more$										
4.11 Soldcrability test Dipping speed $: 25\pm 2.5 \text{ mm/s}$ Dipping time $: 3\pm 0.5 \text{ s}$ Coating quality A minimum of 95% of the surface being immersed Resistance to solder heat test Condition> Terminals of the capacitor shall be immersed into solder bath at $260\pm 5^{\circ}\mathbb{C}$ for $10\pm$ l seconds or $400\pm 10^{\circ}\mathbb{C}$ for $3^{\pm 1}_{-0}$ seconds to $1.5-2.0 \text{ mm}$ from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for $1-2$ hours before measurement. 4.12 Resistance to solder heat test Leakage current Not more than the specified value. Capacitance Change Vithin $\pm 10^{\circ}$ of initial value. tan δ Not more than the specified value. Appearance Not more than the specified value. Capacitance Change 4.13 Change of temperature test Scondition> Temperature Cycle: According to IEC60384-4No.4.7methods, capacitor shall be placed in an oven, the condition according as below: (2)Rated low temperature ($40^{\circ}\mathbb{C}$) ($(-25^{\circ}\mathbb{C})$ 30 ± 2 4.13 temperature test Change of (3)Rated high temperature ($-40^{\circ}\mathbb{C}$) ($-25^{\circ}\mathbb{C}$) 30 ± 2 (1) to (3)=1 cycle, total 5 cycle Condition> Conditions/ The characteristic shall meet the following requirement Leakage current Not more than the specified value. ($10 \pm 10^{\circ}\mathbb{C}$) Not more than the specified value. ($10 \pm 10^{\circ}\mathbb{C}$) Scondit			e 1							
4.11 test The prime is the primage is the prime is the prime is the prima		0.111.114								
Opping line1.320.35Coating qualityA minimum of 95% of the surface being immersedCoating qualityA minimum of 95% of the surface being immersedCondition>Terminals of the capacitor shall be immersed into solder bath at $260 \pm 5^{\circ}$ Cfor10 \pm l seconds or $400 \pm 10^{\circ}$ C for3 $\frac{1}{-0}$ seconds to $1.5 - 2.0$ mm from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for 1-2 hours before measurement.4.12Resistance to solder heat testCriteria>Leakage currentNot more than the specified value. Capacitance ChangeAppearanceThere shall be no leakage of electrolyte.Condition> Temperature Cycle: According to IEC60384-4No.4.7methods, capacitor shall be placed in an oven, the condition according as below:(1) ±20°C(2)Rated low temperature (+40°C) (-25°C)30 ± 2(3)Rated high temperature (+40°C) (-25°C)30 ± 2(1) to (3)=1 cycle, total 5 cycleNot more than the specified value. (1) to (3)=1 cycle, total 5 cycle	4.11	-				/s				
Coating quality A minimum of 95% of the surface being immersed Resistance to solder heat test		lest			: 3±0.5s					
Coaling qualityimmersedimmersedimmersedimmersedimmersedimmersedinto solder bath at $260 \pm 5^{\circ}$ Cfor10±1 seconds or $400 \pm 10^{\circ}$ Cfor3 $\frac{1}{-0}$ seconds to $1.5 - 2.0$ mm from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for 1-2 hours before measurement. Criteria> 4.12Resistance to solder heat testLeakage currentNot more than the specified value. Capacitance Change Within $\pm 10\%$ of initial value. tan δ Not more than the specified value. Appearance4.13Change of temperature test Condition> Temperature Cycle: According to IEC60384-4No.4.7methods, capacitor shall be placed in an oven, the condition according as below:4.13Change of temperature testTemperature (40°C) (-25°C) 30 ± 2 Minutes (3)Rated high temperature (+105°C) 30 ± 2 Minutes (1) to (3)=1 cycle, total 5 cycle 4.13 Change of temperature test Criteria> The characteristic shall meet the following requirement Leakage current Not more than the specified value. Appearance There shall be no leakage of electrolyte.			<criteria></criteria>			<u> </u>	1 .			
4.12Terminals of the capacitor shall be immersed into solder bath at $260\pm5^{\circ}Cfor10\pm$ lseconds or $400\pm10^{\circ}Cfor3^{+}_{-0}$ seconds to $1.5\sim2.0$ mm from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for 1-2 hours before measurement.4.12Resistance to solder heat testLeakage currentNot more than the specified value. Capacitance Change4.13Change of temperature testCondition> Temperature (-40°C) (-25°C)30±2 30±2 Minutes (3)Rated high temperature (+105°C)4.13Change of temperature testCapacitance the following requirement U to (3)=1 cycle, total 5 cycle4.13Change of temperature testCance the following requirement Leakage currentTime test4.13Change of temperature testChange of (1)±20°CNot more than the specified value. Temperature (-40°C) (-25°C)30±2 30±2 Minutes (3)Rated high temperature (+105°C)4.13Change of temperature testChange of (3)Rated high temperature (+105°C)30±2 30±2 Minutes Minutes4.13Change of temperature testChange of (1) to (3)=1 cycle, total 5 cycleCondition Minutes4.13Change of temperature testChange of (1) to (3)=1 cycle, total 5 cycleCondition Minutes4.14Change of temperature testChange of temperature (1) to (3)=1 cycle, total 5 cycleCondition Minutes4.14Change of testChange of testChange of testChange of test4.15Change of (2)R			Coating quality			n of 95% of the surfac	e being			
4.12Iseconds or $400 \pm 10^{\circ} \text{C} \text{for3}_{-0}^{+0}$ seconds to $1.5 \sim 2.0 \text{mm}$ from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for $1 \sim 2$ hours before measurement. 4.12Resistance to solder heat testIseconds or $400 \pm 10^{\circ} \text{C} \text{for3}_{-0}^{+1}$ seconds to $1.5 \sim 2.0 \text{mm}$ from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for $1 \sim 2$ hours before measurement. 4.13Resistance to solder heat testIseconds or $400 \pm 10^{\circ} \text{C} \text{ for3}_{-1}^{+0}$ seconds to $1.5 \sim 2.0 \text{mm}$ from the body of capacitor . Then the capacitor shall be left under the normal temperature and normal humidity for $1 \sim 2$ hours before measurement. 4.13Change of temperature testCondition> Temperature Cycle: According to IEC60384-4No.4.7 methods, capacitor shall be placed in an oven, the condition according as below:4.13Change of temperature testTemperature (Cycle: According to IEC60384-4No.4.7 methods, capacitor shall be placed in an oven, the condition according as below:4.13Change of temperature test(1)+20^{\circ}C (2) (-25^{\circ}C) 30 ± 2 Minutes (3)Rated high temperature (+105^{\circ}C) 30 ± 2 Minutes (1) to (3)=1 cycle, total 5 cycle 4.13Change of temperature testNot more than the specified value. tan δ Not more than the specified value. Appearance There shall be no leakage of electrolyte.4.13 <td></td> <td></td> <td><condition></condition></td> <td></td> <td></td> <td></td> <td></td>			<condition></condition>							
4.12Then the capacitor shall be left under the normal temperature and normal humidity for 1~2 hours before measurement. < Criteria> 4.12Resistance to solder heat testLeakage currentNot more than the specified value. Capacitance Change \mathbf{V} the testLeakage currentNot more than the specified value. Capacitance Change \mathbf{V} the testCapacitance ChangeWithin $\pm 10\%$ of initial value. Temperature (1) the test \mathbf{V} the test Condition> Temperature Cycle: According to IEC60384-4No.4.7methods, capacitor shall be placed in an oven, the condition according as below: \mathbf{V} Temperature Cycle: According to IEC60384-4No.4.7methods, capacitor shall be placed in an oven, the condition according as below: $(1) \pm 20^{\circ}$ ≤ 3 Minutes (2)Rated low temperature (-40^{\circ}C) (-25^{\circ}C) 30 \pm 2 Minutes (1) to (3)=1 cycle, total 5 cycle (1) to (3)=1 cycle, total 5 cycle Criteria> The characteristic shall meet the following requirement Leakage current Not more than the specified value. tan δ Not more than the specified value. Appearance \mathbf{V} Condition> Humidity Test:			Terminals of the capacitor	r shall be	immersed into	o solder bath at 260	\pm 5°C for 10 \pm			
4.12 Resistance to solder heat test Then the capacitor shall be left under the normal temperature and normal humidity for 1~2 hours before measurement. $<\mathbf{Criteria>}$ Leakage current Not more than the specified value. Capacitance Change Within ±10% of initial value. tan δ Not more than the specified value. Appearance There shall be no leakage of electrolyte. Condition> Temperature Cycle: According to IEC60384-4No.4.7methods, capacitor shall be placed in an oven, the condition according as below: Image of temperature test Temperature (-40°C) (-25°C) 30 ± 2 Minutes (-3)Rated high temperature (+105°C) 30 ± 2 Minutes (-1) to (3)=1 cycle, total 5 cycle Criteria> The characteristic shall meet the following requirement Leakage current Not more than the specified value. (1) to (3)=1 cycle, total 5 cycle Criteria> The characteristic shall meet the following requirement Leakage current Leakage current Not more than the specified value. (a) δ Not more than the specified value. (1) to (3)=1 cycle, total 5 cycle Criteria> The characteristic shall meet the following requirement Leakage current Not more than the specified value. Appearance There shall be no leakage of electrolyte. <t< td=""><td></td><td></td><td>1 seconds or $400 \pm 10^{\circ}$C fc</td><td>$r3^{+1}$ seco</td><td>nds to 1.5~2.0</td><td>mm from the body of</td><td>capacitor.</td></t<>			1 seconds or $400 \pm 10^{\circ}$ C fc	$r3^{+1}$ seco	nds to 1.5~2.0	mm from the body of	capacitor.			
4.12 Resistance to solder heat test for 1~2 hours before measurement. 4.12 solder heat test Leakage current Not more than the specified value. Capacitance Change Within $\pm 10\%$ of initial value. Laakage current Not more than the specified value. Appearance There shall be no leakage of electrolyte. Condition> Temperature Cycle: According to IEC60384-4No.4.7methods, capacitor shall be placed in an oven, the condition according as below: Change of temperature test Temperature (-40°C) (-25°C) 30±2 Minutes (-2)Rated low temperature (+105°C) 30±2 Minutes (-1) to (3)=1 cycle, total 5 cycle (1) to (3)=1 cycle, total 5 cycle Criteria> The characteristic shall meet the following requirement Leakage current Not more than the specified value. (1) to (3)=1 cycle, total 5 cycle Criteria> The characteristic shall meet the following requirement Leakage current Not more than the specified value. $ah \delta$ Not more than the specified value. $(1) to (3)=1$ cycle, total 5 cycle Criteria> The characteristic shall meet the following requirement Leakage current Not more than the specified value. <t< td=""><td></td><td></td><td></td><td>-</td><td></td><td></td><td></td></t<>				-						
4.12 Restance to solder heat test Criteria> Leakage current Not more than the specified value. Capacitance Change Within $\pm 10\%$ of initial value. tan δ Not more than the specified value. Appearance There shall be no leakage of electrolyte. 4.13 Change of temperature cycle: According to IEC60384-4No.4.7methods, capacitor shall be placed in an oven, the condition according as below: 4.13 Change of temperature test (1)+20°C (2)Rated low temperature (+40°C) (-25°C) 30 ± 2 Minutes (3)Rated high temperature (+105°C) 30 ± 2 Minutes (1) to (3)=1 cycle, total 5 cycle Criteria> The characteristic shall meet the following requirement Leakage current Not more than the specified value. tan δ Not more than the specified value. Appearance There shall be no leakage of electrolyte. 		D osistanoo to					lai nunnanty			
Leakage current Not more than the specified value. Capacitance Change Within $\pm 10\%$ of initial value. tan δ Not more than the specified value. Appearance There shall be no leakage of electrolyte. Condition> Temperature Cycle: According to IEC60384-4No.4.7methods, capacitor shall be placed in an oven, the condition according as below: Temperature (1)+20°C ≤ 3 Minutes (2)Rated low temperature (-40°C) (-25°C) 30 ± 2 Minutes (3)Rated high temperature (+105°C) 30 ± 2 Minutes (1) to (3)=1 cycle, total 5 cycle $<$ Criteria> The characteristic shall meet the following requirement Leakage current Not more than the specified value. $tan \delta$ <	412			surenient.						
4.13 Change of temperature test Change of temperature test Ch	7.12			N	ot more than th	he specified value.				
AppearanceThere shall be no leakage of electrolyte.AppearanceThere shall be no leakage of electrolyte.Condition> Temperature Cycle: According to IEC60384-4No.4.7methods, capacitor shall be placed in an oven, the condition according as below:Image of (1)+20°CImage of (2)Rated low temperature (-40°C) (-25°C)(2)Rated low temperature (-40°C) (-25°C) 30 ± 2 Minutes (3)Rated high temperature (+105°C)(1) to (3)=1 cycle, total 5 cycleImage of (1) to (3)=1 cycle, total 5 cycleCriteria> The characteristic shall meet the following requirementLeakage current tan δ AppearanceNot more than the specified value. There shall be no leakage of electrolyte.Condition> Humidity Test:			Capacitance Change	W	ithin $\pm 10\%$ c	of initial value.				
4.13Change of temperature test4.13Change of temperature test $(1)+20^{\circ}C$ ≤ 3 Minutes $(2)Rated low temperature (-40^{\circ}C) (-25^{\circ}C)$ 30 ± 2 Minutes $(1)+20^{\circ}C$ $(3)Rated high temperature (-40^{\circ}C) (-25^{\circ}C)$ 30 ± 2 Minutes $(1) to (3)=1$ cycle, total 5 cycle </td <td></td> <td></td> <td>tan δ</td> <td>N</td> <td>ot more than th</td> <td>he specified value.</td> <td></td>			tan δ	N	ot more than th	he specified value.				
4.13Change of temperature testTemperature Cycle:According to IEC60384-4No.4.7methods, capacitor shall be placed in an oven, the condition according as below: 			Appearance	Tł	ere shall be n	o leakage of electroly	rte.			
Change of 4.13Change of temperature testTemperature (1)+20°CTime (1)+20°C $(1)+20°C$ ≤ 3 Minutes $(2)Rated low temperature (-40°C) (-25°C)$ 30 ± 2 Minutes $(3)Rated high temperature (+105°C)$ 30 ± 2 Minutes (1) to $(3)=1$ cycle, total 5 cycle <criteria></criteria> The characteristic shall meet the following requirementLeakage currentNot more than the specified value. tan δ Not more than the specified value. $\tan \delta$ Not more than the specified value.AppearanceThere shall be no leakage of electrolyte. <condition></condition> Humidity Test:		temperature								
4.13Change of temperature testTime (1)+20°CTime (3)Rated low temperature (-40°C) (-25°C)Minutes 30 ± 2 4.13Change of temperature test(2)Rated low temperature (-40°C) (-25°C) 30 ± 2 Minutes 30 ± 2 (1) to (3)=1 cycle, total 5 cycle(1) to (3)=1 cycle, total 5 cycle $<$ Criteria> The characteristic shall meet the following requirementLeakage currentNot more than the specified value. tan δ Not more than the specified value. AppearanceAppearanceThere shall be no leakage of electrolyte.Condition> Humidity Test:										
4.13Change of temperature test $(1)+20^{\circ}C$ $\leqslant 3$ Minutes (2) Rated low temperature $(-40^{\circ}C)$ $(-25^{\circ}C)$ 30 ± 2 Minutes (3) Rated high temperature $(+105^{\circ}C)$ 30 ± 2 Minutes (1) to $(3)=1$ cycle, total 5 cycle $<$ Criteria>The characteristic shall meet the following requirementLeakage currentNot more than the specified value. $\tan \delta$ Not more than the specified value.AppearanceThere shall be no leakage of electrolyte. $<$ Condition>Humidity Test:			-							
4.13Change of temperature test(2) Rated low temperature (-40 °C) (-25 °C) 30 ± 2 Minutes(3) Rated high temperature (+105 °C) 30 ± 2 Minutes(1) to (3)=1 cycle, total 5 cycle Criteria> The characteristic shall meet the following requirementLeakage currentNot more than the specified value. tan δ Not more than the specified value.AppearanceThere shall be no leakage of electrolyte. Condition> Humidity Test:				emperature	;					
4.13temperature test(3)Rated high temperature (+105°C) 30 ± 2 Minutes (1) to (3)=1 cycle, total 5 cycle(1) to (3)=1 cycle, total 5 cycle Criteria> The characteristic shall meet the following requirementLeakage currentNot more than the specified value. tan δ Not more than the specified value.AppearanceThere shall be no leakage of electrolyte. Condition> Humidity Test:										
4.13 temperature test (3)Rated high temperature (+105°C) 30 ± 2 Minutes (1) to (3)=1 cycle, total 5 cycle (1) to (3)=1 cycle, total 5 cycle Criteria> The characteristic shall meet the following requirement Leakage current Not more than the specified value. tan δ Not more than the specified value. Appearance There shall be no leakage of electrolyte. Condition> Humidity Test:					30 ± 2 Minutes					
$<\mathbf{Criteria}>$ The characteristic shall meet the following requirement Leakage current Not more than the specified value. $\tan \delta$ Not more than the specified value. Appearance There shall be no leakage of electrolyte. Condition> Humidity Test:	4.13		(3)Rated high temper							
$\begin{tabular}{ c c c c c } \hline The characteristic shall meet the following requirement & $$ Leakage current & Not more than the specified value. $$ tan $$ Not more than the specified value. $$ Appearance & There shall be no leakage of electrolyte. $$ Condition> $$ Humidity Test: $$ The shall be no leakage of electrolyte $$ The shall be no leakage of electrolyte. $$$			(1) to (3)=1 cycle, total 5 cycle							
Leakage current Not more than the specified value. tan δ Not more than the specified value. Appearance There shall be no leakage of electrolyte. Condition> Humidity Test:			<criteria></criteria>							
$\tan \delta$ Not more than the specified value. Appearance There shall be no leakage of electrolyte. Humidity Test:			The characteristic shall m				_			
Appearance There shall be no leakage of electrolyte. <condition> Humidity Test:</condition>			ŭ							
<condition> Humidity Test:</condition>			tan δ			A				
Humidity Test:			Appearance T		There shall be no leakage of electrolyte.					
	<condition></condition>									
A coording to IEC 60384 ANo 4.12 methods, consister shall be expressed for 500 ± 9										
According to $12 \pm 00564 + 41004$, 12 methods, capacitor shart be exposed for 500 ± 8			According to IEC60384-4No.4.12 methods, capacitor shall be exposed for 500 \pm							
hours in an atmosphere of 90~95% R H .at 40 ± 2 °C, the characteristic change shall					R H .at $40\pm2^\circ$	°C, the characteristic	change shall			
meet the following requirement.				ement.						
<criteria></criteria>							-			
4.14 Damp heat Leakage current Not more than the specified value.	4.14	-					4			
test Capacitance Change Within $\pm 20\%$ of initial value.		test					4			
$\tan \delta$ Not more than 120% of the specified value.						-	4			
Appearance There shall be no leakage of electrolyte.			Appearance	There sh	all be no leaka	age of electrolyte.	_			
		I								

Version

01

Page 9

Vent The fewith y D.C. Vent The curred curr	vent. capacitor is nt selected t able 3> Diameter (m 22.4 or les Over 22.4 eria> ent shall op	s 1	arity re plied.	versed 1	to a DC	power s	ource. Then a
The at 1 Tal Th rat	20Hz and c ple-1 e combined	permissible ripple curr can be applied at maxin value of D.C voltage a nd shall not reverse vo ultipliers: Coefficien Freq. (Hz) Cap.(μ F) ~47 68~470 \geq 560 0.47~220 \geq 270	num op	erating	tempera	ature	
	01						10
Version	01					Page	10



5. It refers to the latest document of "Environment-related Substances standard" (WI-HSPM-QA-072).

	Substances					
Cadmium and cadmium compounds						
Heavy metals	Lead and lead compounds					
ficavy inclais	Mercury and mercury compounds					
	Hexavalent chromium compounds					
	Polychlorinated biphenyls (PCB)					
Chloinated Polychlorinated naphthalenes (PCN)						
organic	Polychlorinated terphenyls (PCT)					
compounds	Short-chain chlorinated paraffins(SCCP)					
	Other chlorinated organic compounds					
Description	Polybrominated biphenyls (PBB)					
Brominated	Polybrominated diphenylethers(PBDE) (including					
organic compounds	decabromodiphenyl ether[DecaBDE])					
compounds	Other brominated organic compounds					
Tributyltin compounds(TBT)						
Triphenyltin compounds(TPT)						
Asbestos						
Specific azo compounds						
Formaldehyde						
Beryllium oxide						
Beryllium copper						
Specific phthalat	es (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP)					
Hydrofluorocarb	on (HFC), Perfluorocarbon (PFC)					
Perfluorooctane	sulfonates (PFOS)					
Specific Benzotr	iazole					

01

Attachment: Application Guidelines

1.Circuit Design

- 1.1 Operating Temperature and Frequency Electrolytic capacitor electrical parameters are normally specified at 20°C temperature and 120Hz frequency. These parameters vary with changes in temperature and frequency. Circuit designers should take these changes into consideration.
- (1) Effects of operating temperature on electrical parameters
 a) At higher temperatures, leakage current and capacitance increase while equivalent series resistance (ESR) decreases.
 - b) At lower temperatures, leakage current and capacitance decrease while equivalent series resistance (ESR) increases.
- (2) Effects of frequency on electrical parameters
 - a) At higher frequencies capacitance and impedance decrease while tand increases.
 - b) At lower frequencies, ripple current generated heat will rise due to an increase in equivalent series resistance (ESR).
- 1.2 Operating Temperature and Life Expectancy See the file: Life calculation of aluminum electrolytic capacitor
- 1.3 Common Application Conditions to Avoid

The following misapplication load conditions will cause rapid deterioration to capacitor electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur causing the pressure relief vent to operate and resultant leakage of electrolyte. Under Leaking electrolyte is combustible and electrically conductive.

(1) Reverse Voltage

DC capacitors have polarity. Verify correct polarity before insertion. For circuits with changing or uncertain polarity, use DC bipolar capacitors. DC bipolar capacitors are not suitable for use in AC circuits.

(2) Charge / Discharge Applications

Standard capacitors are not suitable for use in repeating charge / discharge applications. For charge / discharge applications consult us and advise actual conditions.

(3) Over voltage

Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating are acceptable for short periods of time. Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(4) Ripple Current

Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a capacitor designed for high ripple currents or contact us with your requirements. Ensure that allowable ripple currents superimposed on low DC bias voltages do not cause reverse voltage conditions.

- 1.4 Using Two or More Capacitors in Series or Parallel
- (1) Capacitors Connected in Parallel

The circuit resistance can closely approximate the series resistance of the capacitor causing an imbalance of ripple current loads within the capacitors. Careful design of wiring methods can minimize the possibility of excessive ripple currents applied to a capacitor.

(2) Capacitors Connected in Series

Normal DC leakage current differences among capacitors can cause voltage imbalances. The use of voltage divider shunt resistors with consideration to leakage current can prevent capacitor voltage imbalances.

- 1.5 Capacitor Mounting Considerations
- (1) Double Sided Circuit Boards

Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board.

When dipping into a solder bath, excess solder may collect under the capacitor by capillary action and short circuit the anode and cathode terminals.

(2)Circuit Board Hole Positioning

The vinyl sleeve of the capacitor can be damaged if solder passes through a lead hole for subsequently processed parts. Special care when locating hole positions in proximity to capacitors is recommended.

(3)Circuit Board Hole Spacing

The circuit board holes spacing should match the capacitor lead wire spacing within the specified tolerances. Incorrect spacing can cause excessive lead wire stress during the insertion process. This may result in premature capacitor failure due to short or open circuit, increased leakage current, or electrolyte leakage.

(4) Clearance for Case Mounted Pressure Relief vents

Capacitors with case mounted pressure relief vents require sufficient clearance to allow for proper vent operation. The minimum clearances are dependent on capacitor diameters as proper vent operation. The minimum clearances are dependent on capacitor diameters as follows.

 $\phi 6.3 \text{-} \phi 16 \text{mm:} 2 \text{mm minimum, } \phi 18 \text{-} \phi 35 \text{mm:} 3 \text{mm minimum, } \phi 40 \text{mm or greater:} 5 \text{mm minimum.}$

(5) Clearance for Seal Mounted Pressure Relief Vents

A hole in the circuit board directly under the seal vent location is required to allow proper release of pressure.

Version	01	Page	12

SAMXON	ELECTRONICS
COMPA	NY LIMITED

	Wiring Near the Pressure Relief Vent Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief vent. Flammable, high temperature gas exceeding 100°C may be released which could dissolve the wire insulation and ignite. Circuit Board patterns Under the Capacitor
(8)	Avoid circuit board runs under the capacitor as electrolyte leakage could cause an electrical short. Screw Terminal Capacitor Mounting Do not orient the capacitor with the screw terminal side of the capacitor facing downwards. Tighten the terminal and mounting bracket screws within the torque range specified in the specification.
1.6	Electrical Isolation of the Capacitor
	Completely isolate the capacitor as follows. Between the cathode and the case (except for axially leaded B types) and between the anode terminal and other circuit paths Between the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit paths.
1.7	The Product endurance should take the sample as the standard.
1.8	If conduct the load or shelf life test, must be collect date code within 6 months products of sampling.
1.9	Capacitor Sleeve The vinyl sleeve or laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor. The sleeve may split or crack if immersed into solvents such as toluene or xylene, and then exposed to high temperatures.
	CAUTION!
	 Always consider safety when designing equipment and circuits. Plan for worst case failure modes such as short circuits and open circuits which could occur during use. (1) Provide protection circuits and protection devices to allow safe failure modes. (2) Design redundant or secondary circuits where possible to assure continued operation in case of main circuit failure.
	Capacitor Handling Techniques
(1)	Considerations Before Using Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment. Transient recovery voltage may be generated in the capacitor due to dielectric absorption. If required, this voltage can be discharged
(3)	rated voltage in series with a resistor of approximately $1k\Omega$.
	If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors. Dented or crushed capacitors should not be used. The seal integrity can be compromised and loss of electrolyte / shortened life can result.
(2) (3)	Capacitor Insertion Verify the correct capacitance and rated voltage of the capacitor. Verify the correct polarity of the capacitor before inserting. Verify the correct hole spacing before insertion (land pattern size on chip type) to avoid stress on the terminals. Ensure that the auto insertion equipment lead clinching operation does not stress the capacitor leads where they enter the seal of the
	capacitor. For chip type capacitors, excessive mounting pressure can cause high leakage current, short circuit, or disconnection.
(1) (2) (3)	Manual Soldering Observe temperature and time soldering specifications or do not exceed temperatures of 400 $^{\circ}$ C for 3 seconds or less. If lead wires must be formed to meet terminal board hole spacing, avoid stress on the lead wire where it enters the capacitor seal. If a soldered capacitor must be removed and reinserted, avoid excessive stress to the capacitor leads. Avoid touching the tip of the soldering iron to the capacitor, to prevent melting of the vinyl sleeve.
(1) (2)	Flow Soldering Do not immerse the capacitor body into the solder bath as excessive internal pressure could result. Observe proper soldering conditions (temperature, time, etc.) Do not exceed the specified limits. Do not allow other parts or components to touch the capacitor during soldering.
2.5	Other Soldering Considerations

Rapid temperature rises during the preheat operation and resin bonding operation can cause cracking of the capacitor vinyl sleeve. For heat curing, do not exceed 150° C for a maximum time of 2 minutes.

Version	01	Page	13

- 2.6 Capacitor Handling after Solder
- (1). Avoid movement of the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal.
- (2). Do not use capacitor as a handle when moving the circuit board assembly.
- (3). Avoid striking the capacitor after assembly to prevent failure due to excessive shock.
- 2.7 Circuit Board Cleaning
- (1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up 5 minutes and up to 60° C maximum temperatures. The boards should be thoroughly rinsed and dried. The use of ozone depleting cleaning agents is not recommended in the interest of protecting the environment.
- (2) Avoid using the following solvent groups unless specifically allowed for in the specification;

Halogenated cleaning solvents: except for solvent resistant capacitor types, halogenated solvents can permeate the seal and cause internal capacitor corrosion and failure. For solvent resistant capacitors, carefully follow the temperature and time requirements of the specification. 1-1-1 trichloroethane should never be used on any aluminum electrolytic capacitor.

- Alkali solvents : could attack and dissolve the aluminum case.
- Petroleum based solvents: deterioration of the rubber seal could result.
- Xylene : deterioration of the rubber seal could result.
- Acetone : removal of the ink markings on the vinyl sleeve could result.
- (3) A thorough drying after cleaning is required to remove residual cleaning solvents which may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the maximum rated temperature of the capacitor.
- (4) Monitor the contamination levels of the cleaning solvents during use by electrical conductivity, pH, specific gravity, or water content. Chlorine levels can rise with contamination and adversely affect the performance of the capacitor. Please consult us for additional information about acceptable cleaning solvents or cleaning methods.

2.8 Mounting Adhesives and Coating Agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene based polymers. After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

3. Precautions for using capacitors

3.1 Environmental Conditions

- Capacitors should not be stored or used in the following environments.
- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

3.2 Electrical Precautions

- (1) Avoid touching the terminals of the capacitor as possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuit the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.

4. Emergency Procedures

- (1) If the pressure relief vent of the capacitor operates, immediately turn off the equipment and disconnect form the power source. This will minimize additional damage caused by the vaporizing electrolyte.
- (2) Avoid contact with the escaping electrolyte gas which can exceed 100° C temperatures.
- If electrolyte or gas enters the eye, immediately flush the eyes with large amounts of water.
 - If electrolyte or gas is ingested by month, gargle with water.
 - If electrolyte contacts the skin, wash with soap and water.

5. Long Term Storage

Leakage current of a capacitor increases with long storage times. The aluminum oxide film deteriorates as a function of temperature and time. If used without reconditioning, an abnormally high current will be required to restore the oxide film. This current surge could cause the circuit or the capacitor to fail. After one year, a capacitor should be reconditioned by applying rated voltage in series with a 1000 Ω , current limiting resistor for a time period of 30 minutes. If the expired date of products date code is over eighteen months, the products should be return to confirmation.

5.1 Environmental Conditions

	Version	01		Page	14
--	---------	----	--	------	----

SAMXON	ELECTRONICS
COMPA	NY LIMITED

ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

The capacitor shall be not use in the following condition:

(1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.

(2) Direct contact with water, salt water, or oil.

(3) High humidity conditions where water could condense on the capacitor.

(4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, or ammonia.

(5) Exposure to ozone, radiation, or ultraviolet rays.

(6) Vibration and shock conditions exceeding specified requirements.

6. Capacitor Disposal

When disposing of capacitors, use one of the following methods.

Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise).

Capacitors should be incinerated at high temperatures to prevent the release of toxic gases such as chlorine from the polyvinyl chloride sleeve, etc.

Dispose of as solid waste.

NOTE: Local laws may have specific disposal requirements, which must be followed.

Version	01	Page	15